

11/14/03

Substitute for Form 1449B/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)				Complete if Known	
				Applicati n Number	10 713 852
				Filing Date	Filed Herewith 11/14/03
				First Named Inventor	Asli B. Ucok
				Group Art Unit	2815
				Examiner Name	Jasmine clark
Sheet	2	of	2	Attorney Docket Number	UOM 0319 PUS
OTHER PRIOR ART -- NON PATENT LITERATURE DOCUMENTS					
Examiner Initials *	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.			T ²
jbe		AL-SARAWI, SAID F., ET AL., A Review of 3-D Packaging Technology, IEE Transactions On Components, Packaging And Manufacturing Technology, 21, No. 1, pp. 2-14, February 1998			
		SCHUENEMANN, MATTHIAS, ET AL., MEMS Modular Packaging And Interfaces, Proc. Of The 50 th Electronic Components And Technology Conference, pp. 681-688, 2000			
		MILLER, DAVID C., ET AL., Microrelay Packaging Technology Using Flip-Chip Assembly, Proc. Of The 13 th International Conference On Micro-Electro-Mechanical Systems, pp. 265-270, Miyazaki, Japan, January 23-27, 2000			
		MASON, ANDREW, ET AL., A Generic Multi-Element Microsystem For Portable Wireless Applications, Proc. Of The IEEE, pp. 1733-1746, August, 1998			
		GOLDSTEIN, HARRY, Packages Go Vertical, IEEE Spectrum, pp. 46-51, August, 2001			
		GANN, KEITH D., Neo-Stacking Technology, HDI Magazine, December, 1999			
		BAKIR, MUHANNAD S., ET AL., Sea of Leads (SOL) Ultrahigh Density Wafer-Level Chip Input/Output Interconnections For Gigascale Integration (GSI), IEEE Transactions On Electron Devices, Vol. 50, No. 10, October, 2003			
jbe		MURARI, BRUNO, Bridging The Gap Between The Digital And Real Worlds: The Expanding Rule of Analog Interface Technologies, 2003 IEEE International Solid-State Circuits Conference, Plenary Session 1.3, February 10, 2003			

Examiner Signatur	Jasmine clark	Date Consid red	12/09/04
----------------------	---------------	--------------------	----------

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹Unique citation designation number. ²Applicant is to place a check mark here if English language Translation is attached.

* Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. * Applicant is to place a check mark here if English language Translation is attached.